

PLC497

LILTRA LOW CAPACITANCE TVS ARRAY

APPLICATIONS

- ✓ Low Voltage Wireless Equipment
- ✓ Sensor & Control Circuits
- ✓ Ethernet 10/100 Base T
- ✔ FireWire

IEC COMPATIBILITY (EN61000-4)

- ✓ 61000-4-2 (ESD): Air 15kV, Contact 8kV
- ✓ 61000-4-4 (EFT): 40A 5/50ns
- ✓ 61000-4-5 (Surge): 24A, 8/20µs Level 2(Line-Ground) & Level 3(Line-Line)

FEATURES

- ✓ 250 Watts Peak Pulse Power per Line (tp = 8/20µs)
- ✓ Unidirectional Configuration
- ✓ ESD Protection > 25 kilovolts
- ✓ Low Clamping Voltage < 5 Volts
 </p>
- **✓** ULTRA LOW CAPACITANCE: 2.5pF
- ✔ RoHS Compliant in Lead-Free Versions

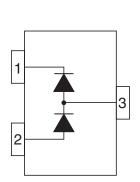
MECHANICAL CHARACTERISTICS

- ✓ Molded JEDEC SOT-23
- ✓ Weight 8 milligrams (Approximate)
- ✔ Available in Tin-Lead or Lead-Free Pure-Tin Plating(Annealed)
- ✓ Solder Reflow Temperature:

Tin-Lead - Sn/Pb, 85/15: 240-245°C Pure-Tin - Sn, 100: 260-270°C

- ✓ Flammability rating UL 94V-0
- ✓ 8mm Tape and Reel Per EIA Standard 481
- ✔ Device Marking: Marking Code

PINCONFIGURATION





SOT-23

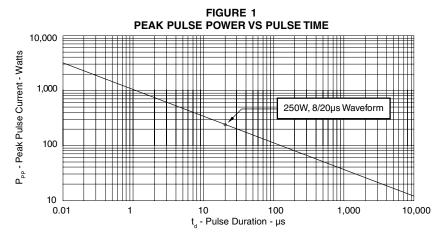
DEVICE CHARACTERISTICS

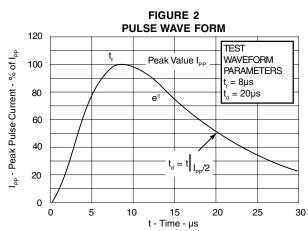
MAXIMUM RATINGS @ 25°C Unless Otherwise Specified						
PARAMETER	SYMBOL	VALUE	UNITS			
Peak Pulse Power - t _p = 8/20μs (See Figure 1)	P _{PP}	250	W			
Operating Temperature	T_{J}	-55°C to 150°C	∞			
Storage Temperature	T _{STG}	-55°C to 150°C	℃			

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified								
PART NUMBER	DEVICE MARKING CODE	RATED STAND-OFF VOLTAGE V _{WM} VOLTS	MINIMUM BREAKDOWN VOLTAGE (See Note 1) @1mA V(BR) VOLTS	MAXIMUM REVERSE LEAKAGE CURRENT (See Note 1) @V V I D HA	MAXIMUM CLAMPING VOLTAGE (See Note 1) (See Fig. 2) @ 8/20µs V _C @ _{PP}	MAXIMUM WORKING INVERSE BLOCKING VOLTAGE (See Note 2) V WE VOLTS	INVERSE BLOCKING LEAKAGE CURRENT (See Note 2)	MAXIMUM CAPACITANCE (See Note 3) @ 0V, 1MHz C pF
		VOLIO	VOLIO	μ, ,	*C ○ 'PP	VOLIO	μ.,	ρ.
PLC497	LC	1.0	1.3	20	5.0V @ 50A	75	1.0	2.5

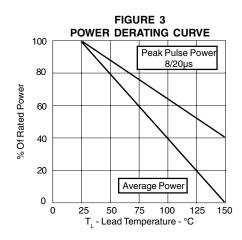
Note 1: Apply positive voltage from pin2 to 1. Note 2: Apply positive voltage from pin 1 to 2.

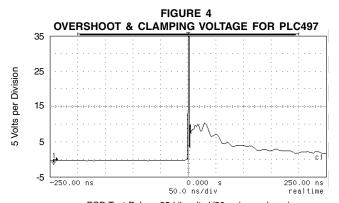
Note 3: Capcitance from pin 1 to 2 < 2.5pF.



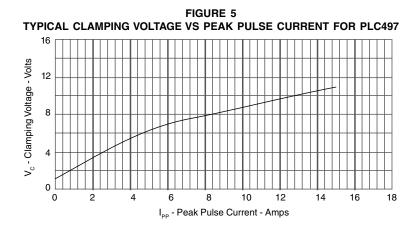


GRAPHS





ESD Test Pulse: 25 kilovolt, 1/30ns (waveshape)



APPLICATION NOTE

The PLC497 is an ultra low capacitance, bidirectional array that is designed to protect I/O or high speed data lines from the damaging effects of ESD or EFT. This product has a surge capability of 250 Watts P_{pp} per line for an 8/20µs wave form and offers ESD protection > 40kV.

DIFFERENTIAL-MODE CONFIGURATION (Figure 1)

The PLC497 is designed to protect one unidirectional line. Figure 1 shows a typical differential-mode (line to line) I/O port protection circuit application. To achieve bidirectional protection, two PLC497 units are placed in parallel with opposing polarities within the circuit layout.

Circuit connectivity is as follows:

- ✔ Pins 1 and 2 of each device connected to datalines
- ✔ Pin 3 is not connected

COMMON-MODE CONFIGURATION (Figure 2)

The PLC497 can provide protection for sensor circuit applications. Figure 2 is a typical common-mode (line to ground) sensor circuit application. To achieve bidirectional protection in this application, a second pair of TVS devices is added in parallel with opposing polarities where pins 2 are connected to the line, pins 1 connected to ground and pins 3 unconnected.

Circuit connectivity is as follows:

- ✔ Pins 1 each device connected to datalines
- ✔ Pins 2 each device connected to ground
- ✔ Pin 3 is not connected

CIRCUIT BOARD LAYOUT RECOMMENDATIONS

Circuit board layout is critical for Electromagnetic Compatibility (EMC) protection. The following guidelines are recommended:

- The protection device should be placed near the input terminals or connectors, the device will divert the transient current immediately before it can be coupled into the nearby traces.
- The path length between the TVS device and the protected line should be minimized.
- All conductive loops including power and ground loops should be minimized.
- The transient current return path to ground should be kept as short as possible to reduce parasitic inductance.
- Ground planes should be used whenever possible.
 For multilayer PCBs, use ground vias.

Figure 1. Typical Differential-Mode i/o Port Protection Circuit

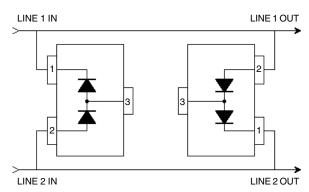
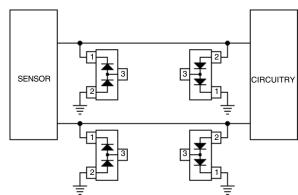
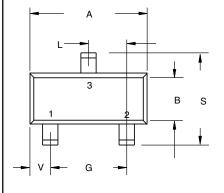


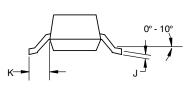
Figure 2. Typical Common-Mode Sensor Protection Circuit

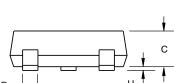


PACKAGE OUTLINE & DIMENSIONS

PACKAGE OUTLINE







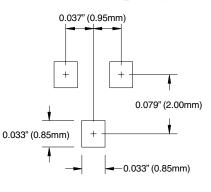
SOT-23



PACKAGE DIMENSIONS

	MILLIM	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	2.80	3.04	0.1102	0.1197	
В	1.20	1.40	0.0472	0.0551	
С	0.89	1.11	0.0350	0.0440	
D	0.37	0.50	0.0150	0.0200	
G	1.78	2.04	0.0701	0.0807	
Н	0.013	0.100	0.0005	0.0040	
J	0.085	0.177	0.0034	0.0070	
K	0.45	0.60	0.0180	0.0236	
L	0.89	1.02	0.0350	0.0401	
S	2.10	2.50	0.0830	0.0984	
V	0.45	0.60	0.0177	0.0236	

MOUNTINGPAD



NOTES

- 1. Dimensioning and tolerances per ANSI Y14.5M, 1985.
- 2. Controlling Dimension: Inches
- 3. Pin 3 is the cathode (Unidirectional Only).
- 4. Dimensions are exclusive of mold flash and metal burrs.

TAPE & REEL ORDERING NOMENCLATURE

- 1. Surface mount product is taped and reeled in accordance with EIA-481.
- 2. Suffix -T7 = 7 Inch Reel 3,000 pieces per 8mm tape, i.e., PLC497-T7.
- 3. Suffix -T13 = 13 Inch Reel 10,000 pieces per 8mm tape, i.e., PLC497-T13.
- 4. Suffix LF = Lead-Free, Pure-Tin Plating, i.e., PLC497-LF-T7.

Outline & Dimensions: Rev 1 - 11/01, 06012

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ProTek Devices

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